
2. Specification

2-1. GSM General Specification

	GSM900 Phase 1	GSM850 Phase 1	DCS1800 Phase 1	PCS1900
Freq. Band[MHz] Uplink/Downlink	880~915 925~960	824.2~848.8 869.2~893.8	1710~1785 1805~1880	1850~1910 1930~1990
ARFCN range	0~124 & 975~1023	128~251	512~885	512~810
Tx/Rx spacing	45MHz	45MHz	95MHz	80MHz
Mod. Bit rate/ Bit Period	270.833kbps 3.692us	270.833kbps 3.692us	270.833kbps 3.692us	270.833kbps 3.692us
Time Slot Period/Frame Period	576.9us 4.615ms	576.9us 4.615ms	576.9us 4.615ms	576.9us 4.615ms
Modulation	0.3GMSK	0.3GMSK	0.3GMSK	0.3GMSK
MS Power	33dBm~5dBm	33dBm~5dBm	30dBm~0dBm	30dBm~0dBm
Power Class	5pcl ~ 19pcl	5pcl ~ 19pcl	0pcl ~ 15pcl	0pcl ~ 15pcl
Sensitivity	-102dBm	-102dBm	-100dBm	-100dBm
TDMA Mux	8	8	8	8
Cell Radius	35Km	35Km	2Km	-

2-2. GSM Tx Power Class

TX Power control level	GSM850 GSM900	TX Power control level	DCS1800	TX Power control level	PCS1900
5	33±3 dBm	0	30±3 dBm	0	30±3 dBm
6	31±3 dBm	1	28±3 dBm	1	28±3 dBm
7	29±3 dBm	2	26±3 dBm	2	26±3 dBm
8	27±3 dBm	3	24±3 dBm	3	24±3 dBm
9	25±3 dBm	4	22±3 dBm	4	22±3 dBm
10	23±3 dBm	5	20±3 dBm	5	20±3 dBm
11	21±3 dBm	6	18±3 dBm	6	18±3 dBm
12	19±3 dBm	7	16±3 dBm	7	16±3 dBm
13	17±3 dBm	8	14±3 dBm	8	14±3 dBm
14	15±3 dBm	9	12±4 dBm	9	12±4 dBm
15	13±3 dBm	10	10±4 dBm	10	10±4 dBm
16	11±5 dBm	11	8±4dBm	11	8±4dBm
17	9±5 dBm	12	6±4 dBm	12	6±4 dBm
18	7±5 dBm	13	4±4 dBm	13	4±4 dBm
19	5±5 dBm	14	2±5 dBm	14	2±5 dBm
		15	0±5 dBm	15	0±5 dBm

2-3. GSM EDGE TX power class

Only in Master

TX Power control level	GSM900 GSM850	TX Power control level	DCS1800	TX Power control level	PCS1900
8	27±3 dBm	2	26±3 dBm	2	26±3 dBm
9	25±3 dBm	3	24±3 dBm	3	24±3 dBm
10	23±3 dBm	4	22±3 dBm	4	22±3 dBm
11	21±3 dBm	5	20±3 dBm	5	20±3 dBm
12	19±3 dBm	6	18±3 dBm	6	18±3 dBm
13	17±3 dBm	7	16±3 dBm	7	16±3 dBm
14	15±3 dBm	8	12±3 dBm	8	12±3 dBm
15	13±3 dBm	9	10±3 dBm	9	10±3 dBm
16	11±5 dBm	10	14±3 dBm	10	14±3 dBm
17	9±5 dBm	11	12±4 dBm	11	12±4 dBm
18	7±5 dBm	12	10±4 dBm	12	10±4 dBm
19	5±5 dBm	13	8±4dBm	13	8±4dBm
		14	6±4 dBm	14	6±4 dBm
		15	4±4 dBm	15	4±4 dBm

3. Operation Instruction and Installation

Main Function

- 3.2 Mega Pixel Camera
- 3.0" WQVGA 262K TFT TOUCH SCREEN
- "TOUCH WIZ" Full Touch UI
- BlueTooth V2.1+EDR
- USB 2.0
- SMS/MMS/EMS (OMA v1.2)
- MP3/AMR/AAC/AAC+/e-AAC+/WMA
- Quad Band(EGSM900/DCS,PCS,EDGE)
- MicroSD Card Support
- External Memory
- FM Radio Support, Radio Data System
- Full Internet Browsing
- Accelerometer rotation
- Face Detection & Smile Shot

4. Array course control

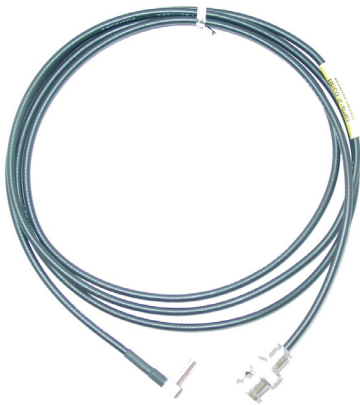
4-1. Software Adjustments



Test Jig (GH99-36900A)



Test Cable (GH39-01160A)



RF Test Cable (GH39-00985A)



Adapter (GH99-38251A)

4-2. Software Downloading

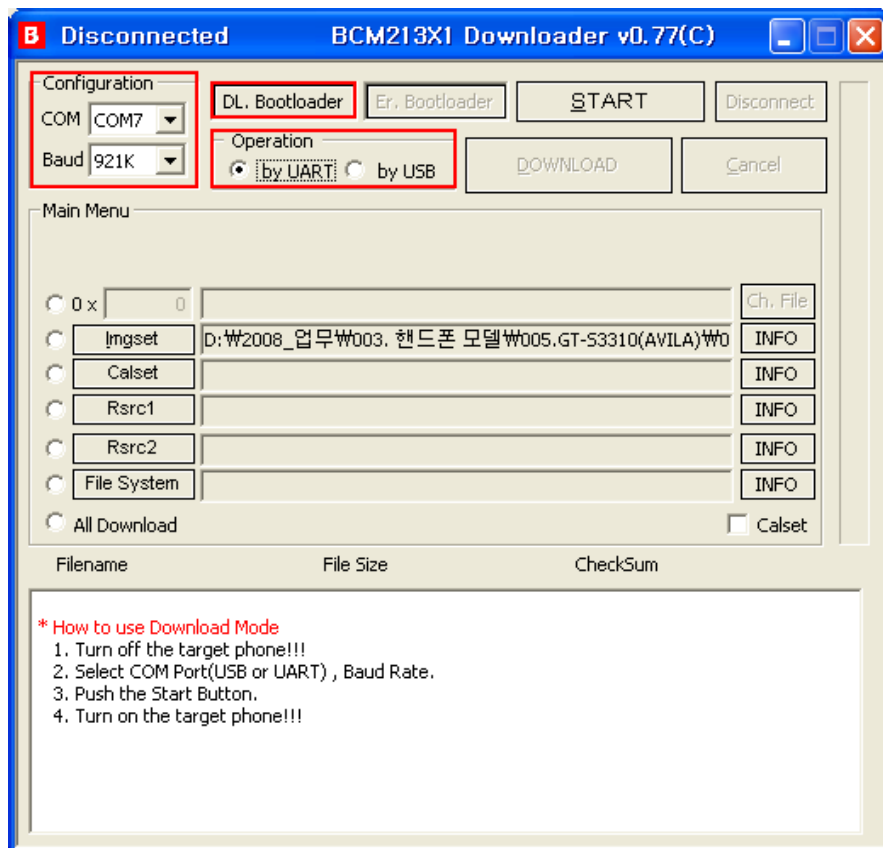
4-2-1. Pre-requisite for Downloading

- Downloader Program(**BCM213x1 Downloader v0.xx(D)**)
 - Downloader Program(**Downloader V5.51 (ELY x.0)**)
 - GT-S5230 Mobile Phone
 - Data Cable
-
- BOOT file, BIN file, RC1 file, RC2 file, FFS file, Calset file

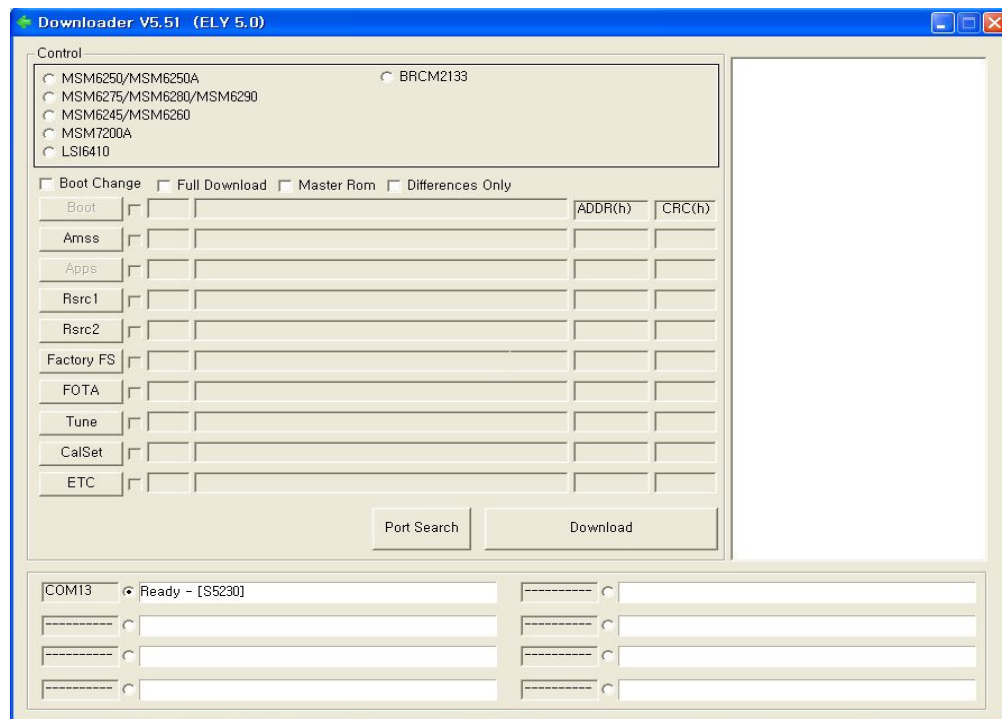
4-2-2. S/W Downloader Program

- Load the binary download program by executing the
" **BCM213x1 Downloader v0.xx(C)** "

1. Select the connected serial port and the rate of speed.
2. Select the check box, Connect cable to phone after Click **DL.Bootloader** Button.

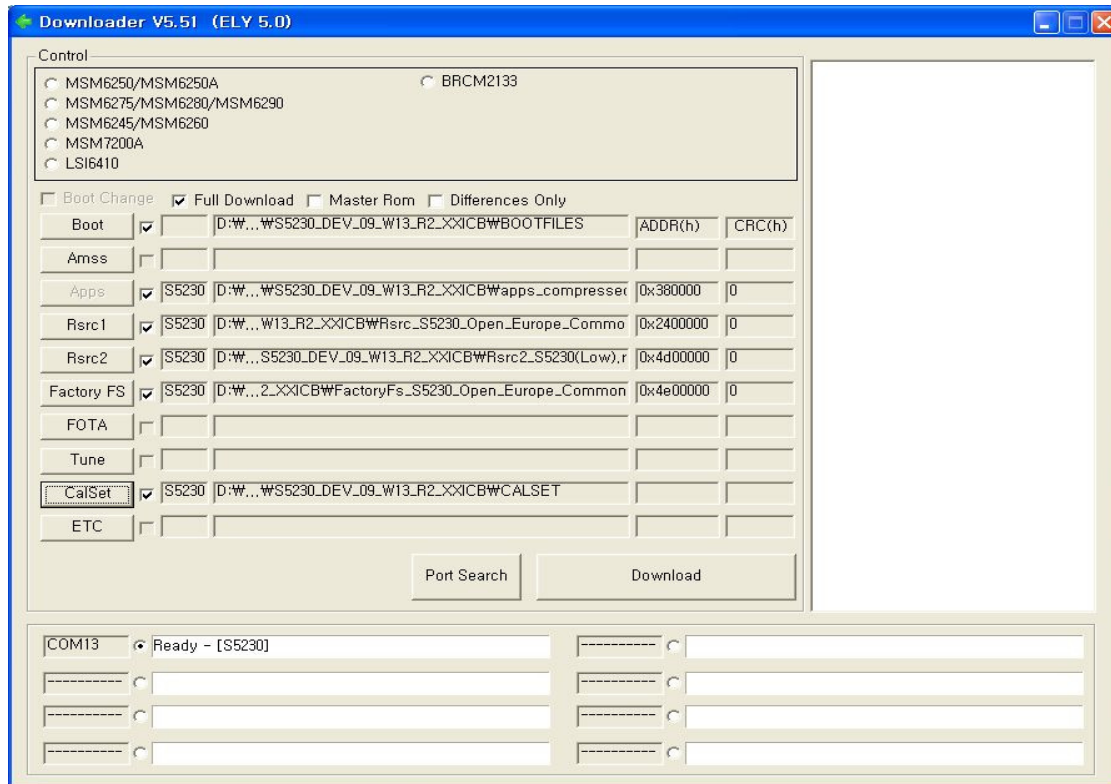


3. Execute the **Downloader V5.51 (ELY x.0)**, When Complete DL.Bootloader.
Click the "Port Search" button.



4. Check the "Full Download". and
Select the file(s) what you want to download
 - click 'Boot' to select a Boot folder.
 - drag in Bin, Rc1, Rc2, Ffs files
 - click 'calset' to select a Calset folder.

5. Check the All Download & Calset , Click the Download Botton,



6. Confirm the downloaded version name and etc. :

***#1234#**

Full Reset :

***0206*3855#**

10. Reference data

10-1. Reference Abbreviate

AAC: Advanced Audio Coding.

AVC : Advanced Video Coding.

BER : Bit Error Rate

BPSK: Binary Phase Shift Keying

CA : Conditional Access

CDM : Code Division Multiplexing

C/I : Carrier to Interference

DMB : Digital Multimedia Broadcasting

EN : European Standard

ES : Elementary Stream

ETSI: European Telecommunications Standards Institute

MPEG: Moving Picture Experts Group

PN : Pseudo-random Noise

PS : Pilot Symbol

QPSK: Quadrature Phase Shift Keying

RS : Reed-Solomon

SI : Service Information

TDM : Time Division Multiplexing

TS : Transport Stream

1. Safety Precautions

1-1. Repair Precaution

- Repair in Shield Box, during detailed tuning.
Take specially care of tuning or test,
because specipicty of cellular phone is sensitive for surrounding interference(RF noise).
- Be careful to use a kind of magnetic object or tool,
because performance of parts is damaged by the influence of manetic force.
- Surely use a standard screwdriver when you disassemble this product,
otherwise screw will be worn away.
- Use a thicken twisted wire when you measure level.
A thicken twisted wire has low resistance, therefore error of measurement is few.
- Repair after separate Test Pack and Set because for short danger (for example an
overcurrent and furious flames of parts etc) when you repair board in condition of
connecting Test Pack and tuning on.
- Take specially care of soldering, because Land of PCB is small and weak in heat.
- Surely tune on/off while using AC power plug, because a repair of battery charger is
dangerous when tuning ON/OFF PBA and Connector after disassembling charger.
- Don't use as you pleases after change other material than replacement registered on SEC
System.
Otherwise engineer in charge isn't charged with problem that you don't keep this rules.

1-2. ESD(Electrostatically Sensitive Devices) Precaution

Several semiconductor may be damaged easily by static electricity. Such parts are called by ESD(Electrostatically Sensitive Devices), for example IC,BGA chip etc. Read Precaution below. You can prevent from ESD damage by static electricity.

- Remove static electricity remained your body before you touch semiconductor or parts with semiconductor. There are ways that you touch an earthed place or wear static electricity prevention string on wrist.
- Use earthed soldering steel when you connect or disconnect ESD.
- Use soldering removing tool to break static electricity. , otherwise ESD will be damaged by static electricity.
- Don't unpack until you set up ESD on product. Because most of ESD are packed by box and aluminum plate to have conductive power,they are prevented from static electricity.
- You must maintain electric contact between ESD and place due to be set up until ESD is connected completely to the proper place or a circuit board.